



MEYER BURGER

# PiXDRO IP410

## Advanced industrial inkjet printer

The **PiXDRO IP410** is a **versatile inkjet printer** for functional printing applications, and is designed for **process engineering** and **manufacturing of series of products**. The IP410 platform is a multipurpose system that will allow you to work at the frontiers of inkjet printing technology. It can be employed for a wide range of applications such as **semiconductor packaging, PCB, printed electronics, photo voltaic, display** and **chemical machining**. Because of its open architecture, the IP410 can be **connected to automated product handlers** or other processing equipment.

### Key Advantages

- Large substrate table and connectivity to automated product handling
- Fast and accurate exchange of printheads and inks
- Open architecture enables user defined and application specific functionalities
- Automated printhead maintenance (capping, purging, spitting, wiping)
- Easy transfer of process recipes to PiXDRO mass production printers

### Main Features and Options

- Compatible with solvent based, aqueous, hot melt and UV-curable inks.
- Advanced Drop Analysis (ADA) for drop analysis and optimization.
- Integrated vision systems for droplet inspection, substrate alignment and print inspection.
- Substrate chuck with vacuum clamping, heating and cooling option.
- Customized product holders.
- Recirculating ink supply for nanoparticle inks.
- Integrated UV or NIR curing.
- Single and dual printheads.
- Interfacing to customized and automated product handling.
- Printhead storage station, with jetting function to avoid nozzle clogging.

### Choice of Industrial Printheads

- Fujifilm Dimatix S-class, SE3/SX3, Sapphire, Emerald, DMC.
- Konica Minolta KM512, KM1024i.
- OCE CrystalPoint C29.

## Technical Data

<b>Maximum substrate size</b>	415 x 530 mm
<b>Max. substrate thickness</b>	15 mm
<b>Substrate chuck</b>	Vacuum clamping; optional product specific chuck
<b>Substrate temperature control</b>	Heating up to 90 °C
<b>Stage accuracy</b>	+/- 25 µm (3σ)
<b>Stage precision</b>	+/- 5 µm (3σ)
<b>Motion</b>	X, Y, Z, Printhead rotation up to 90 degrees
<b>Print speed</b>	Up to 500 mm/s
<b>Printheads</b>	16 - 1024 nozzles; 1 - 80 pL dropsize
<b>Printhead exchange time</b>	< 2 minutes, kinematic calibration
<b>Printhead maintenance</b>	Purging, spitting, capping, wiping
<b>Vision systems</b>	Drop view and print image view
<b>Operation</b>	Intuitive HMI; open source recipe scripting
<b>Image formats</b>	Bitmap, Gerber, postscript, PDF
<b>Ink types</b>	Solvent based, nanoparticle, aqueous, hotmelt, UV-curable
<b>Ink viscosity</b>	2 - 20 cP
<b>Ink supply</b>	15 mL header tank; optional bulk ink supply
<b>Advanced drop analysis (optional)</b>	Automatic calculation of drop volume, speed and angle
<b>Integrated post processing (optional)</b>	UV pinning or curing
<b>Footprint (w x d x h)</b>	Approx. 1720 x 1080 x 1990 mm (excl. PC and monitor)
<b>Weight</b>	Approx. 825 kg

